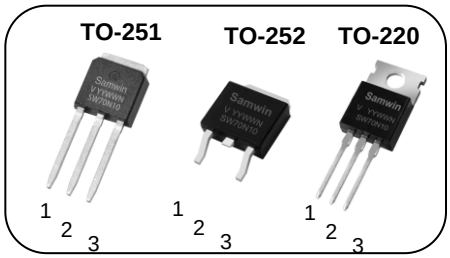
Samwin®

SW70N10V

N-channel Enhanced mode TO-251/TO-252/TO-220 MOSFET

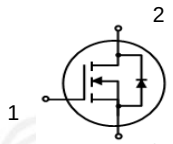
Features

- High ruggedness
- Low $R_{DS(ON)}$ (Typ 11.7mΩ)@V_{GS}=10V
  Low $R_{DS(ON)}$ (Typ 12.4mΩ)@V_{GS}=4.5V
- Low Gate Charge (Typ 117nC)
- Improved dv/dt Capability
- 100% Avalanche Tested
- Application:Synchronous Rectification, Li Battery Protect Board, Inverter



1. Gate 2. Drain 3. Source

BV_{DSS} : 95V
I_D : 70A
$R_{DS(ON)}$: 11.7mΩ @V_{GS}=10V
12.4mΩ @V_{GS}=4.5V



General Description

This power MOSFET is produced with advanced technology of SAMWIN.
This technology enable the power MOSFET to have better characteristics, including Fast switching time, low on resistance, low gate charge and especially excellent Avalanche characteristics.

LEAD-FREE RoHS

Order Codes

Item	Sales Type	Marking	Package	Packaging
1	SW I 70N10V	SW70N10V	TO-251	TUBE
2	SW D 70N10V	SW70N10V	TO-252	REEL
3	SW P 70N10V	SW70N10V	TO-220	TUBE

Absolute maximum ratings

Symbol	Parameter		Value			Unit
			TO-251	TO-252	TO-220	
V_{DSS}	Drain to source voltage		95			V
I_D	Continuous drain current (@T_C=25°C)		70*			A
	Continuous drain current (@T_C=100°C)		44*			A
I_{DM}	Drain current pulsed	(note 1)	280			A
V_{GS}	Gate to source voltage		±20			V
E_{AS}	Single pulsed avalanche energy	(note 2)	351			mJ
E_{AR}	Repetitive avalanche energy	(note 1)	24			mJ
dv/dt	Peak diode recovery dv/dt	(note 3)	5			V/ns
P_D	Total power dissipation (@T_C=25°C)		69.4	125	179	W
	Derating factor above 25°C		0.55	1.00	1.4	W/°C
T_{STG}, T_J	Operating junction temperature & storage temperature		-55 ~ + 150			°C
T_L	Maximum lead temperature for soldering purpose, 1/8 from case for 5 seconds.		300			°C

*. Drain current is limited by junction temperature.

Thermal characteristics

Symbol	Parameter	Value			Unit
		TO-251	TO-252	TO-220	
R_{thjc}	Thermal resistance, Junction to case	1.8	1.0	0.7	°C/W
R_{thja}	Thermal resistance, Junction to ambient	92		56	°C/W

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Electrical characteristic (T_C = 25°C unless otherwise specified)

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
Off characteristics						
BV_{DSS}	Drain to source breakdown voltage	V_{GS}=0V, I_D=250uA	95			V
ΔBV_{DSS} / ΔT_J	Breakdown voltage temperature coefficient	I_D=250uA, referenced to 25°C		0.1		V/°C
I_{DSS}	Drain to source leakage current	V_{DS}=95V, V_{GS}=0V			1	uA
		V_{DS}=76V, T_C=125°C			50	uA
I_{GSS}	Gate to source leakage current, forward	V_{GS}=20V, V_{DS}=0V			100	nA
	Gate to source leakage current, reverse	V_{GS}=-20V, V_{DS}=0V			-100	nA
On characteristics						
$V_{GS(TH)}$	Gate threshold voltage	V_{DS}=V_{GS}, I_D=250uA	1		3	V
$R_{DS(ON)}$	Drain to source on state resistance	V_{GS}=10V, I_D=30A		11.7	13	mΩ
		V_{GS}=4.5V, I_D=30A		12.4	14	mΩ
G_{fs}	Forward transconductance	V_{DS}=10V, I_D=35A		119		S
Dynamic characteristics						
C_{iss}	Input capacitance	V_{GS}=0V, V_{DS}=25V, f=1MHz		8110		pF
C_{oss}	Output capacitance			315		
C_{rss}	Reverse transfer capacitance			314		
$t_{d(on)}$	Turn on delay time	V_{DS}=50V, I_D=70A, R_G=25Ω, V_{GS}=10V (note 4,5)		21		ns
t_r	Rising time			87		
$t_{d(off)}$	Turn off delay time			403		
t_f	Fall time			156		
Q_g	Total gate charge	V_{DS}=80V, V_{GS}=10V, I_D=70A (note 4,5)		117		nC
Q_{gs}	Gate-source charge			9.5		
Q_{gd}	Gate-drain charge			43		
R_g	Gate resistance	V_{DS}=0V, Scan F mode		1.14		Ω

Source to drain diode ratings characteristics

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
I_S	Continuous source current	Integral reverse p-n Junction diode in the MOSFET			70	A
I_{SM}	Pulsed source current				280	A
V_{SD}	Diode forward voltage drop.	I_S=70A, V_{GS}=0V			1.4	V
t_{rr}	Reverse recovery time	I_S=70A, V_{GS}=0V, dI_F/dt=100A/us		36		ns
Q_{rr}	Reverse recovery charge			56		nC

※. Notes

1. Repeatitive rating : pulse width limited by junction temperature.
2. L =1.76mH, I_{AS} =20A, V_{DD} = 50V, R_G=25Ω, Starting T_J = 25°C
3. I_{SD} ≤70A, di/dt = 100A/us, V_{DD} ≤ BV_{DSS}, Staring T_J =25°C
4. Pulse Test : Pulse Width ≤ 300us, duty cycle ≤ 2%
5. Essentially independent of operating temperature.

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Fig. 1. On-state characteristics

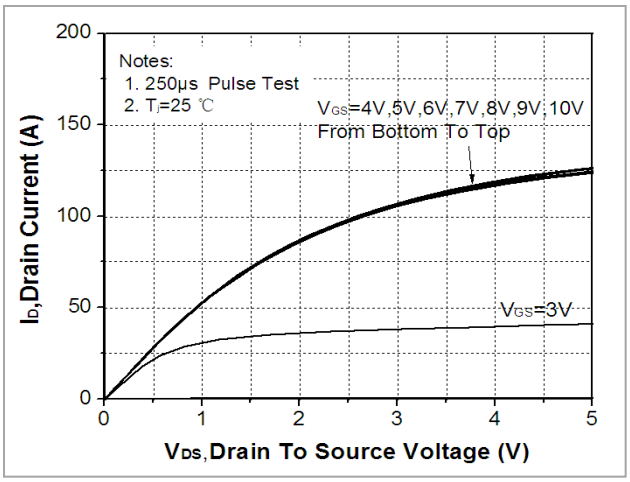


Fig. 2. Transfer characteristics

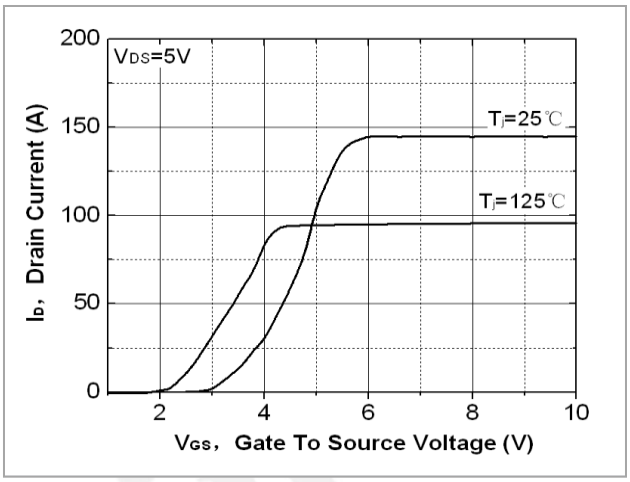


Fig. 3. On-resistance variation vs. drain current and gate voltage

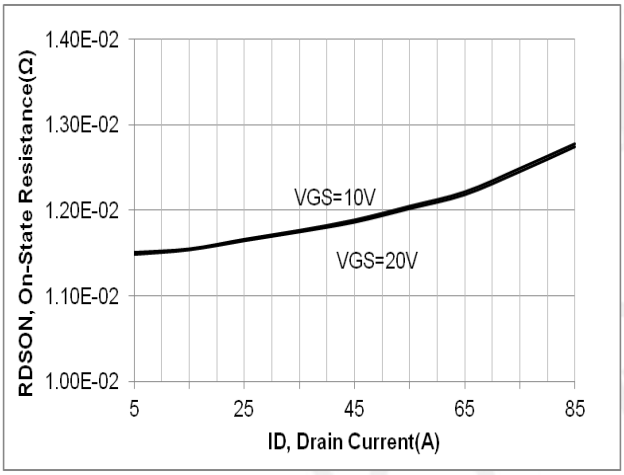


Fig. 4. On state current vs. diode forward voltage

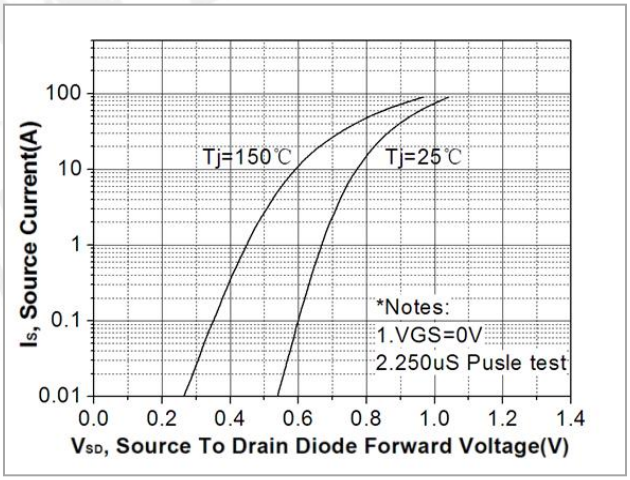


Fig 5. Breakdown voltage variation vs. junction temperature

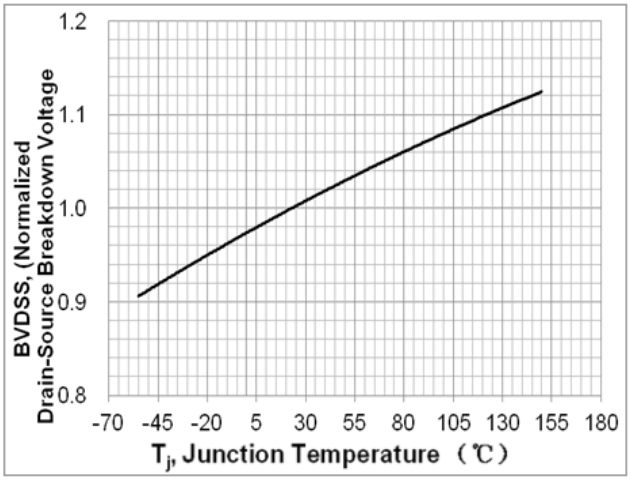
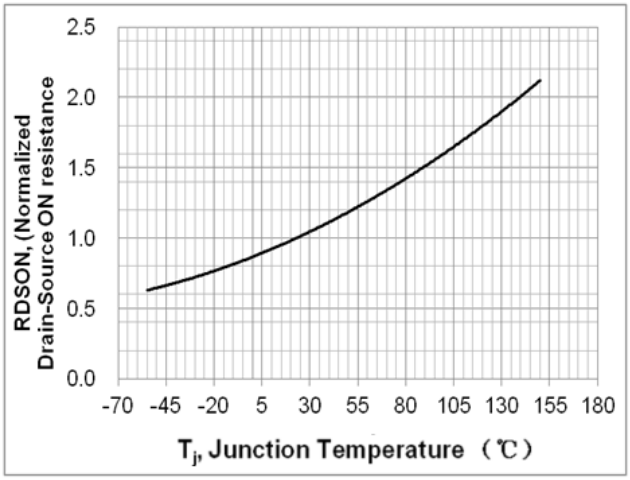


Fig. 6. On resistance variation vs. junction temperature



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Fig. 7 Gate charge characteristics

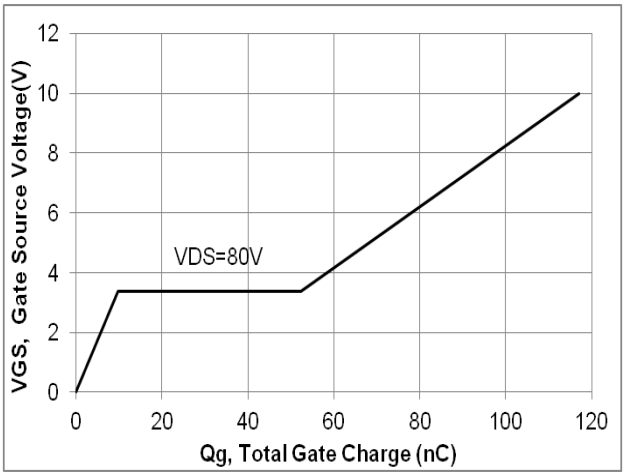


Fig. 8. Capacitance characteristics

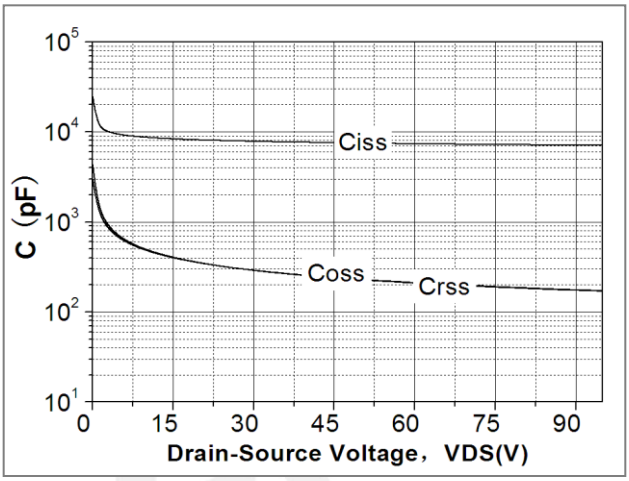


Fig. 9. Maximum safe operating area(TO-251)

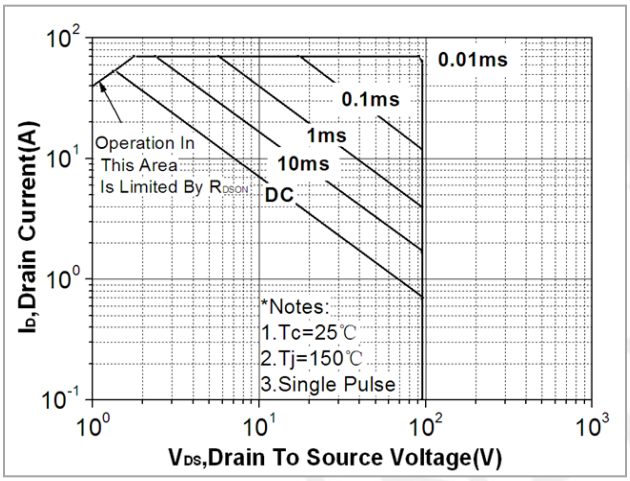


Fig. 10. Maximum safe operating area(TO-252)

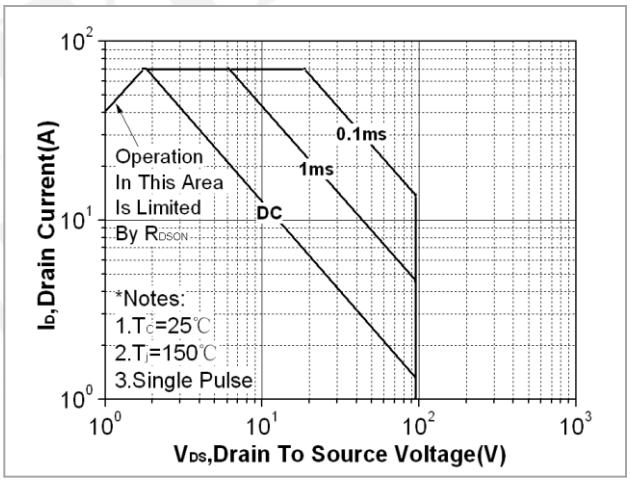
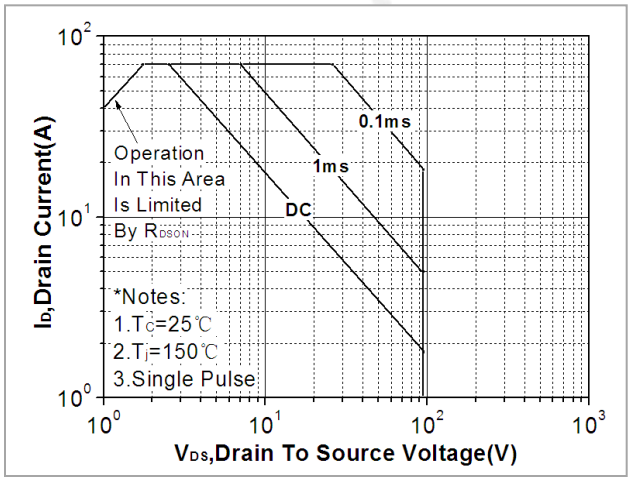


Fig. 11. Maximum safe operating area(TO-220)



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Fig. 12. Transient thermal response curve(TO-251)

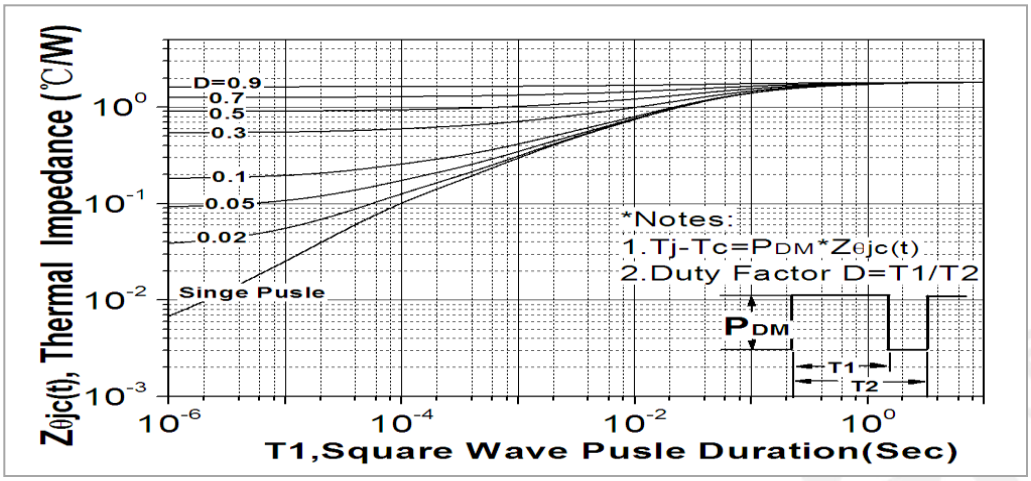


Fig. 13. Transient thermal response curve(TO-252)

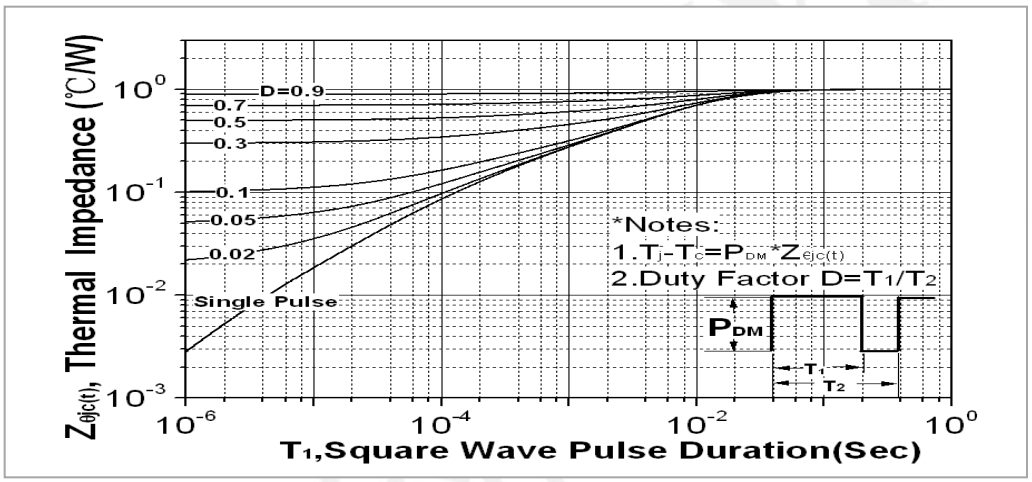
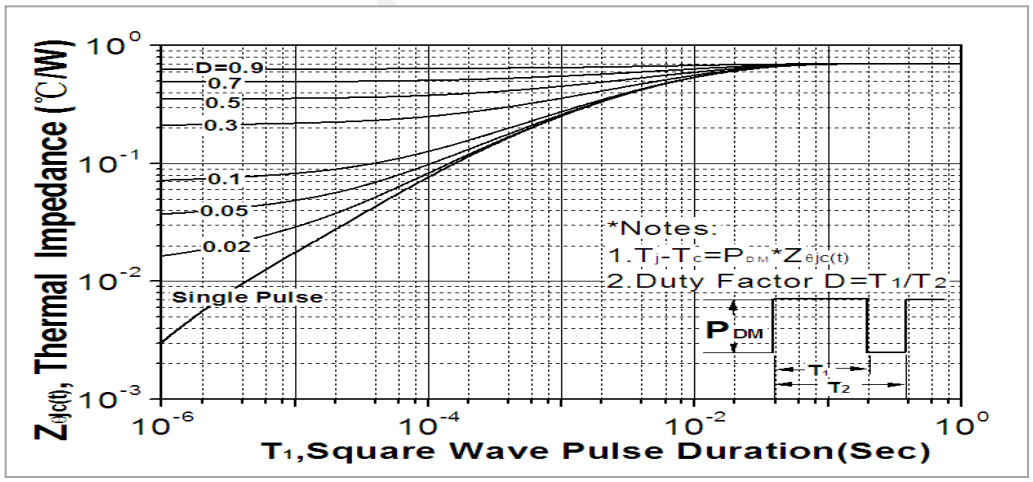


Fig. 14. Transient thermal response curve(TO-220)



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Fig. 15. Gate charge test circuit & waveform

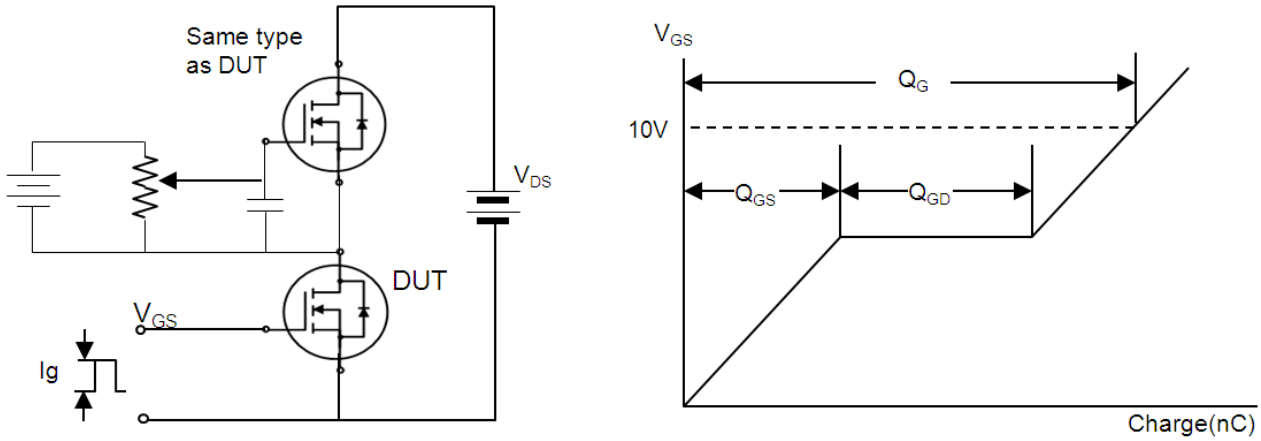


Fig. 16. Switching time test circuit & waveform

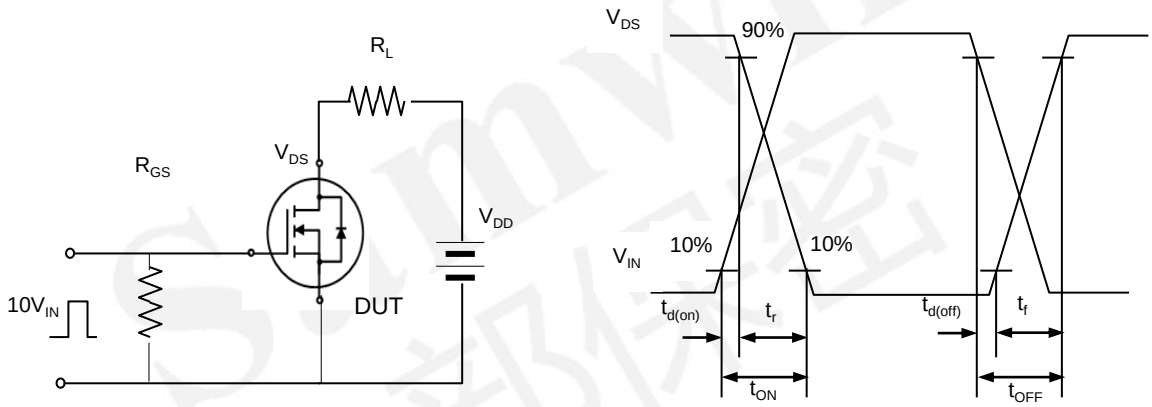
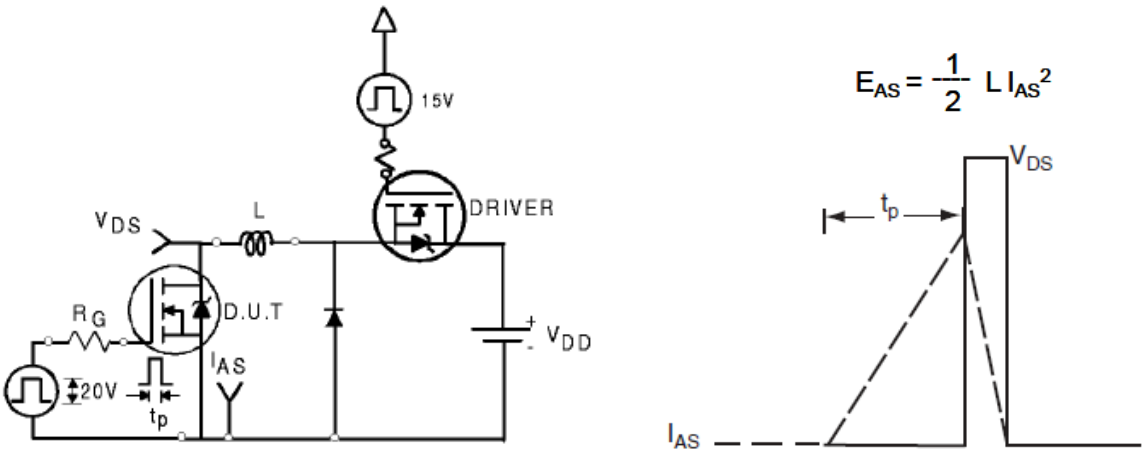
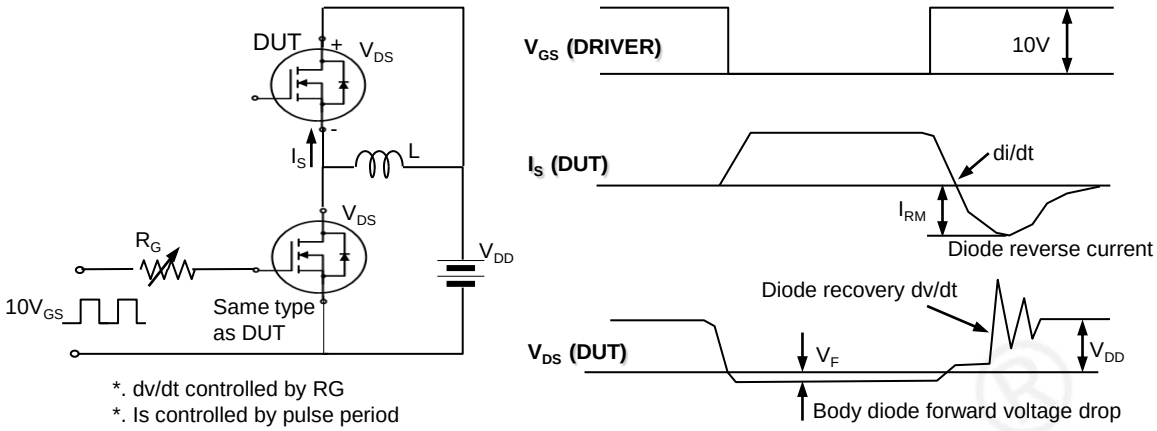


Fig. 17. Unclamped Inductive switching test circuit & waveform



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Fig. 18. Peak diode recovery dv/dt test circuit & waveform



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* This product has passed the PCT,TC,HTRB,HTGB,HAST,PC and Solderdunk reliability test

* Qualification standards can also be found on the Web site (**http://www.semipower.com.cn**)

* Suggestions for improvement are appreciated, Please send your suggestions to **samwin@samwinsemi.com**

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